

# SPECIFICATION FOR LCD MODULE

# MODULE NO: AFS320240TG-5.7-A000001 REVISION NO: 00

Customer's Approval:

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)	Fr. Li	Sep-10-2011
CHECKED BY	Ylh	Sep-10-2011
APPROVED BY	Sean	Sep-10-2011

# **DOCUMENT REVISION HISTORY**

Version	DATE	DESCRIPTION	CHANGED BY
00	Sep-10-2011	First Issue	Fr.li
	l		

# **CONTENTS**

1. Features & Mechanical specifications	1
2. Dimensional Outline	2
3. Pin Description	3
4. Absolute Maximum Ratings	4
5. Electrical Characteristics	4
6. Backlight Specification	4
7. Electro-Optical Characteristics	5
8. AC Characteristics	8
9. Quality Specification	16

# 1. Features & Mechanical Specifications

Item	Contents LCD	Unit
LCD Type	TFT / Transmissive / Normally White	
Viewing direction	12 O'clock	
Backlight	White LED x 20	
Interface	RGB interface	
Driver IC	HX8218-C01 + HX8615C	
Outline Dimension	$125.4(W) \times 102.0(H) \times 6.0(T)$	mm
Glass area (W×H×T)	120.28 × 90.64 / 95.74 × 1.0	mm
Active area (W×H)	115.2 × 86.4	mm
Number of Dots	320(RGB)×240	
Dot pitch (W×H)	0.36 × 0.36	mm
Pixel pitch (W×H)	0.12 × 0.36	mm
Operating Temperature	-10 $\sim$ +60	°C
Storage temperature	$-20 \sim +70$	°C

## 2. Dimensional Outline

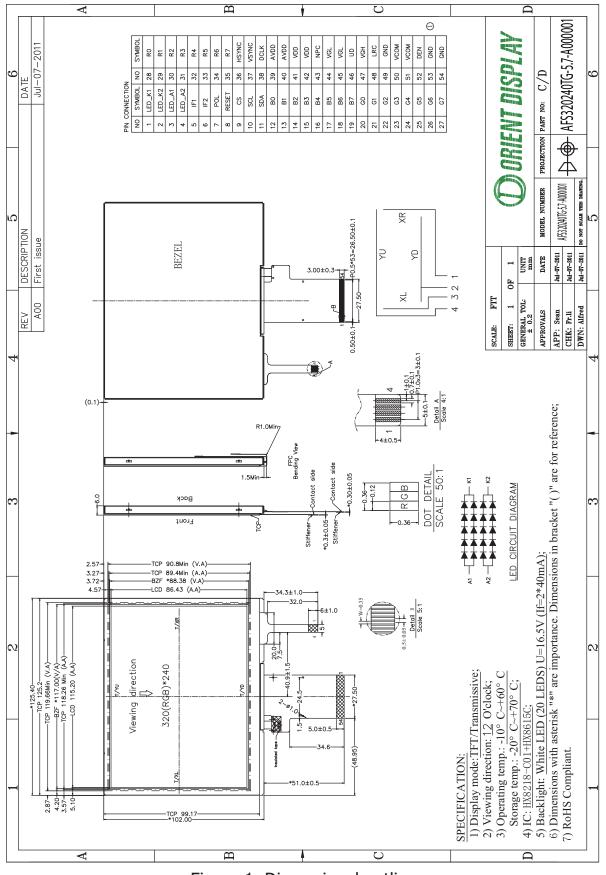


Figure 1. Dimensional outline

# **<u>3. Pin Description</u>**

PIN No.	SYMBOL	Function
1	LEDK1	LED Backlight Cathode
2	LEDK2	LED Backlight Cathode
3	LEDA1	Back-light LED Anode
4	LEDA2	Back-light LED Anode
5	IF1	
6	IF2	Control the input data format. NOTE (1)
7	POL	Polarity select for the line inversion control signal. NOTE (2) When POL=L, output voltage is negative polarity. When POL=H, output voltage is positive polarity.
8	RESET	Reset Signal (Low Active, 10us at least).
9	CS	Serial Interface Chip Select.
10	SCL	Serial Interface Clock.
11	SDA	Serial Interface Data.
12~19	B0~B7	Blue Data Input. NOTE (3)
20~27	G0~G7	Green Data Input. NOTE (3)
28~35	R0~R7	Red Data Input. NOTE (3)
36	HSYNC	Horizontal sync input in digital RGB mode. Or HREF input in CCIR601 mode.(Short to GND if not used)
37	VSYNC	Vertical sync input in digital RGB mode. Or V123 input in CCIR601 mode.(Short to GND if not used)
38	DCLK	Data Clock.
39-40	AVDD	Analog Power (+5.0V)
41-42	VDD	Digital Power (+3.3V)
43	NPC	NTSC or PAL mode auto detection result When NPC=H, NTSC mode is selected. When NPC=L, PAL mode is selected.
44-45	VGL	Gate Off Power (-10.0V)
46	UD	Up/down scan setting. When UD=H, reverse scan. When UD=L, normal scan.
47	VGH	Gate On Power (+15.0V)
48	LRC	This pin controls the output shifting direction as listed below.LRC=H: STHOUT1• • • OUT960STHOLRC=L: STHOUT960• • • OUT1STHO
49	GND	Ground
50-51	VCOM	Vcom Driving Input NOTE (2)
52	DEN	Data Enable signal
53-54	GND	Ground

NOTE:

(1) Input data format.

IF1	IF2	Input data format
L	L	Serial RGB
Н	L	Parallel RGB
L	Н	CCIR601
Н	Н	CCIR656

(2)The polarity of VCOM (Pin 50,51) should be generated from POL (Pin 7)
(3) In serial RGB or CCIR601/656 input mode, only R0~R7 are used, and others are to connect to GND.

# 4. Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Power Supply Voltage	VDD	-0.3 to +7.0	V
Input Voltage	AVDD	-0.3 to +7.0	
Operating Temperature range	Тор	-10 to +60	°C
Storage Temperature range	Тѕт	-20 to +70	°C

# **5. Electrical Characteristics**

#### **DC** Characteristics

Item	Symbol	Min.	Type.	Max.	Unit
Power Supply Voltage	VDD	3	3.3	3.6	V
Power Supply Voltage	AVDD	3.8	5	5.5	

# 6. Backlight Characteristics

(White LED $\times$ 5 in series) $\times$ 4 in Pa			(Ta =	25°C)		
Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	IF=2 * 40mA	-	16.5	-	V
Uniformity	$\triangle Bp$	-	80	-	-	%
Luminance for LCD	Lv	IF=2 * 40mA	4000	-	-	cd/m <sup>2</sup>

# **7. Electro-Optical Characteristics**

ltem		Symbol	Conditions	Spe	ecificati	ons	Unit	Note			
		Symbol Conditions		Min.	Тур.	Max.	Unit	INOLE			
Transmittance	•	T%			8.1		%				
Contrast Ratio	o	CR		150	250	-					
Response Tin	10	T <sub>R</sub>		-	15	30	ms	All left side data			
Response III	le	T <sub>F</sub>		-	35	50	ms	are based on			
	Red	X <sub>B</sub>		0.610	0.640	0.670		CMO's following			
	Red	Y <sub>R</sub>	Viewing normal angle	0.314	0.344	0.374		condition -			
	Green	X <sub>G</sub>	$\theta_{\rm X} = \theta_{\rm Y} = 0^{\circ}$	0.268	0.298	0.328					
Chromaticity	Green	Y <sub>G</sub>	0x = 0y =0	0.553	0.583	0.613		NTSC: 58% LC: CMO LC			
Chiomaticity	Blue	Хв		0.102	0.132	0.162		Light : C light			
	Dice	Yв		0.107	0.137	0.167		(Machine:BM5A)			
	White	Xw		0.282	0.312	0.342		Polarizer without			
	vvnite	Yw		0.319	0.349	0.379		DBEF			
	Hor.	$\theta_{X+}$		-	45			Reference Only			
Viewing	Hor.	θχ.	Center		45	1	daa				
Angle	Ver	θ <sub>Y+</sub>	CR≥10	-	15		deg.				
	Ver.	θγ.		-	35						

light source: C light, using CMO TN	LC+Polarizer, reference only)
-------------------------------------	-------------------------------

\*Note (1) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

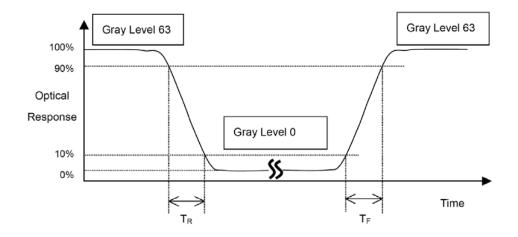
L63: Luminance of gray level 63

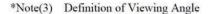
L0: Luminance of gray level 0

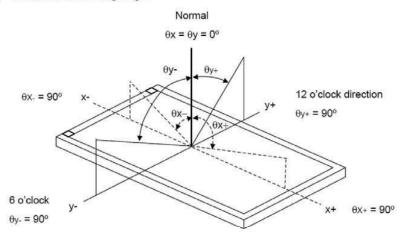
CR = CR(5)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (5).

\*Note (2) Definition of Response Time (TR, TF):



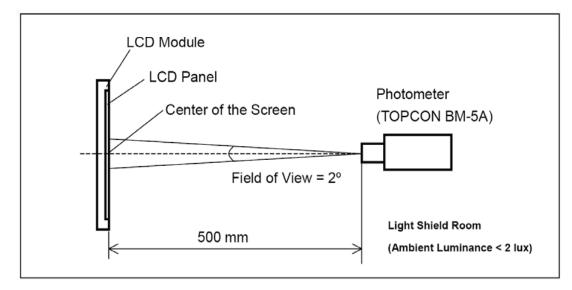




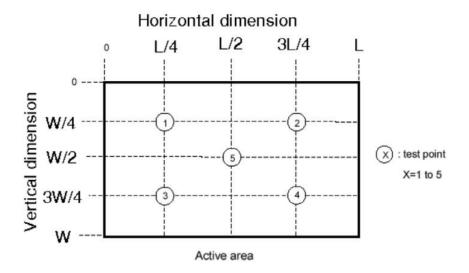
\*\*\* The above "Viewing Angle" is the measuring position with Largest Contrast Ratio; not for good image quality. View Direction for good image quality is 12 O'clock. Module maker can increase the "Viewing Angle" by applying Wide View Film.

\*Note (4) Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.







# **8. AC Characteristics**

### 8.1 Input signal characteristics

## Digital Serial RGB interface (960x240 resolution)

PARAMETER		Symbol	Min.	Тур.	Max.	Unit
CLK period		Tosc	-	52	-	ns
Data setup time		Τ <sub>su</sub>	12	-		ns
Data hold time		T <sub>HD</sub>	12	-	-	ns
IHS period		Тн	-	1224	- //	Tosc
IHS pulse width		T <sub>HS</sub>	5	90	0.01	Tosc
IHS setup time		T <sub>cr</sub>	12	-	11-2	ns
IHS hold time		T <sub>Cf</sub>	12	-	3	ns
IVS pulse width		T <sub>VS</sub>	1	3	5	T <sub>H</sub>
IVS setup time		T <sub>Vr</sub>	12	0	<u> </u>	ns
IVS hold time		T <sub>Vf</sub>	12	L (6//S)	- X	μs
IVS-DEN time	NTSC	T <sub>VSE</sub>	-	18		T <sub>H</sub>
IVS-DEN time	PAL	T <sub>VSE</sub>	A.	26	1	T <sub>H</sub>
IHS-DEN time		T <sub>HE</sub>	108	204	264	U T <sub>osc</sub>
DEN pulse width		T <sub>EP</sub>	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	960		Tosc
DEN-STH time		TDES	$\sim$	3	)	Tosc
NTSC			1.	262.5	1 -	Тн
IVS period	PAL	( )	)`.	312.5	-	Тн

Note: When SYNC mode is used, 1st data start from 204th CLK after IHS falling

## Digital Parallel RGB interface (960x240 resolution)

PARAMETE	ER	Symbol	Min.	Тур.	Max.	Unit
CLK period	211	Tosc	5-	156	-	ns
Data setup time	17	Tsu	12	-		ns
Data hold time	9		12	-	-	ns
IHS period		)T <sub>H</sub>	-	408		Tosc
IHS pulse width	1011	T <sub>HS</sub>	5	30	-	Tosc
IHS setup time	$\langle \rangle$	T <sub>cr</sub>	12	-		ns
IHS hold time		T <sub>cf</sub>	12	-	-	ns
IVS pulse width		T <sub>vs</sub>	1	3	5	T <sub>H</sub>
IVS setup time		T <sub>Vr</sub>	12	-	14	ns
IVS hold time		T <sub>Vf</sub>	12	-	-	μs
IVS-DEN time	NTSC	T <sub>VSE</sub>	-	18	-	Тн
IVS-DEN time	PAL	T <sub>VSE</sub>	-	26		Тн
IHS-DEN time		T <sub>HE</sub>	36	68	88	Tosc
DEN pulse width		T <sub>EP</sub>	-	320		Tosc
DEN-STH time		TDES		1	27	Tosc
NTSC		-	-	262.5	-	Тн
IVS period	PAL	-	-	312.5	-	T <sub>H</sub>

Note: When SYNC mode is used, 1st data start from 68th CLK after IHS falling.

#### CCIR601/656 Interface

PARAMETER	Symbol	Min.	Тур.	Max.	Unit
CLK period	Tosc	-	37	-	ns
Data setup time	Τ <sub>su</sub>	12	-	-	ns
Data hold time	T <sub>HD</sub>	12	-	-	ns
IVS falling to IHS rising time for odd field	T <sub>HVO</sub>	1	-	-	T <sub>osc</sub>
IVS falling to IHS falling time for even field	T <sub>HVE</sub>	1	-	- <	Tosc

## Hardware reset timing

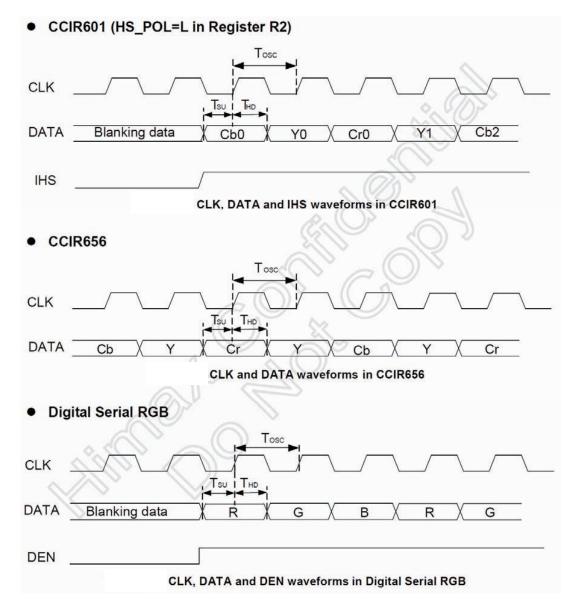
				V1/16	
PARAMETER	Symbol	Min.	Тур.	Max.	Unit
RESETB low pulse width	T <sub>RSB</sub>	10	(	14	μs
STB to Vsync Setup Time	T <sub>STB</sub>	20		×.	ns

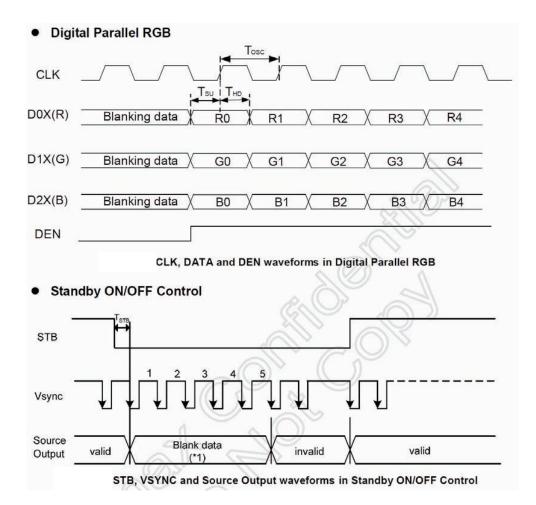
# 8.2 Output signal characteristics for digital input signal

PARAMETER	l	Symbol	Min.	Тур.	Max.	Unit
Rising time		T,	14-0	- ((	10	ns
Falling time		T <sub>f</sub>	$(\mathcal{V})$		10	ns
Internal STH setup til	me	T <sub>sus</sub>	12	5	-	ns
Internal STH hold tim	e	T <sub>HDS</sub>	12		-	ns
Internal data setup tir	ne 🖊	TSUD	60			ns
Internal data hold tim	e	T <sub>HDD</sub>	40	-	-	ns
OEH pulse width		Тоен	A	1248	-	ns
OEV pulse width	OEV pulse width		( ( ) )	4992		ns
CKV pulse width	CKV pulse width			3744	-	ns
IHS-OEH time	V	Th	⊇.	4368	-	ns
IHS-CKV time	71	T <sub>2</sub>	-	2496	-	ns
IHS-OEV time		T <sub>3</sub>	-	624	-	ns
IHS-POL time		)/T <sub>4</sub>	-	4368		ns
STV setup time	$\sim$	T <sub>SUV</sub>	-	1872	-	ns
STV pulse width		T <sub>STV</sub>	-	1	-	T <sub>H</sub>
NTSC NTSC		T <sub>VS1</sub>	-	19	-	T <sub>H</sub>
IVS-STV time	PAL	T <sub>VS1</sub>	-	27	-	T <sub>H</sub>
OEH-STV time		T <sub>OES</sub>	-	2		T <sub>H</sub>
Output settling time		T <sub>ST</sub>	-	12	20	μs

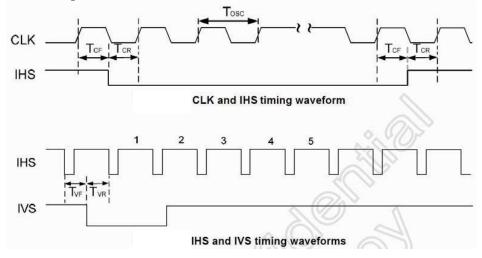
### 8.3 Timing Controller Timing Chart

### 8.3.1 Clock and Data waveforms



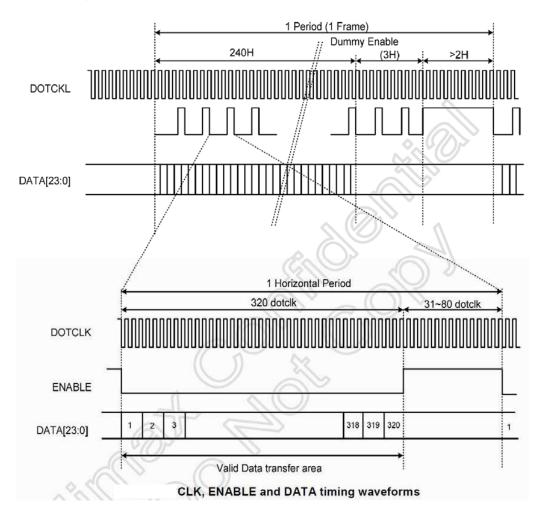


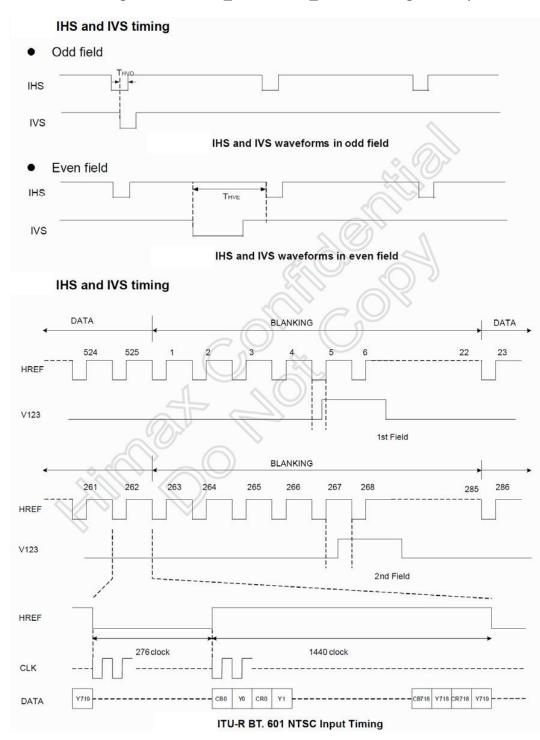
#### 8.3.2 Clock and Sync waveforms



## 8.3.3 Digital RGB timing waveform

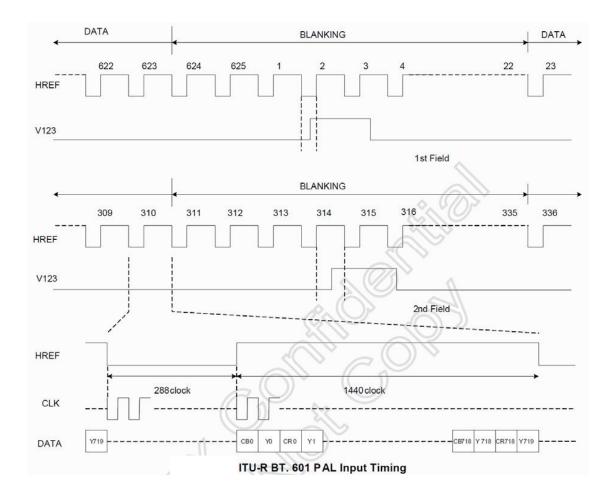
## • DE Only Mode





### 8.3.4 CCIR601 timing waveform VS\_POL=H, HS\_POL=L in Register R2)

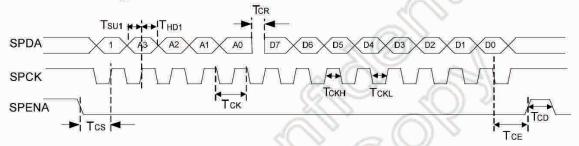
13



## 8.3.5 SPI timing characteristics

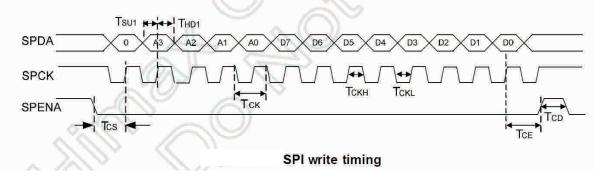
PARAMETER	Symbol	Min.	Тур.	Max.	Unit
SPCK period	T <sub>ck</sub>	60	-	-	ns
SPCK high width	Тскн	30	221	32	ns
SPCK low width	TCKL	30	<u></u>	12	ns
Data setup time	T <sub>SU1</sub>	12	<u>2265</u>	12	ns
Data hold time	T <sub>HD1</sub>	12			ns
SPENA to SPCK setup time	T <sub>cs</sub>	20	-175 	1	ns
SPENA to SPDA hold time	T <sub>CE</sub>	20	-	-	ns
SPENA high pulse width	T <sub>CD</sub>	50	-	- //	ns
SPDA output latency	T <sub>CR</sub>	.=:	1/2	0. 6/	Тск

# SPI read timing



SPI read timing

• SPI write timing



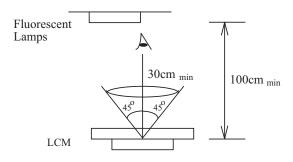
# **9.Quality Specifications**

## All The raw material are Rohs complicant.

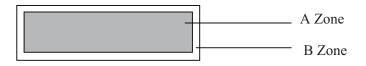
#### 9.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: viewing area B Zone: outside viewing area

# 9.2 Specification of quality assurance

### AQL inspection standard

## Sampling method: MIL-STD-105E, Level II, single sampling

# Defect classification (Note: \* is not including)

Classify		Item	Note	AQL
Major	Display state	Short or open circuit		0.65
		LC leakage		
		Flickering	1	
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	$\left  \right $
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

### Note on defect classification

No.	Item			Criterion	
1	Short or open circuit	Not allow			
	LC leakage				
	Flickering				
	No display				
	Wrong viewing direction				
	Wrong Back-light				
2	Contrast defect		Refe	r to approval sam	ple
	Background color deviation				
3	Point defect, Black spot, dust		7	Point Size	Acceptable Qty.
	(including Polarizer)	X		¢ <u>≤</u> 0.10	Disregard
				0.10 <\$\$≤0.20	3
	$\phi = (X+Y)/2$		_	0.20 <\$≤ 0.25	2
	(21, 1)/2		_	0.25 <\$≤ 0.30	1
				ф <i>&gt;</i> 0.30	0
			Uni	t: mm	
4	Line defect,	↓			
				Line	Acceptable Qty.
	Scratch	$  \leftrightarrow  $	L	W	
		L		0.02≥W	Disregard
			4.0≥L	$0.03 \ge W > 0.02$	2
			2.0≥L 1.0≥L	0.05≥W>0.03 0.1>W>0.05	1
				0.1 <w< td=""><td>Applied as point defect</td></w<>	Applied as point defect
		Unit: mm			
5	Rainbow	Not more than t	two color	changes across th	ne viewing area.

No	Item	Criterion
6	Chip Remark: X: Length direction Y: Short	$X \qquad Y \qquad Acceptable criterion$ $X \qquad Y \qquad Z \qquad \forall \qquad T \qquad T \qquad X \qquad Y \qquad Z \qquad \forall \qquad T \qquad T$
	direction Z: Thickness direction t: Glass thickness W: Terminal Width	$\begin{array}{c c} X & Y \\ \hline & X & Y \\ \hline & & \\ \hline & & \\ \hline & & \\ Z \end{array}$ Acceptable criterion $\begin{array}{c c} X & Y & Z \\ \hline & \leq 2 & 0.5 \text{mm} & \leq t \end{array}$
		$\begin{array}{c c} & Acceptable criterion \\ \hline X & Y & Z \\ \hline \leqslant 3 & \leqslant 2 & \leqslant t \\ \hline \$ hall not reach to ITO \\ \hline \end{array}$
		$W_{\underline{y}} \xrightarrow{Y} \psi$ Acceptable criterion $X \xrightarrow{Y} Z$
		$\begin{array}{c c} & Y \\ & & \\ \hline \\ & & \\ & \\ & \\ & \\ & \\ & \\ &$

No.	Item	Criterion			
7	Segment pattern W = Segment width $\phi = (X+Y)/2$	(1) Pin hole $\boxtimes < 0.10 \text{ mm} \text{ is acceptable.}$ $Y \xrightarrow{V} Y \xrightarrow{V} Y$ $\downarrow \downarrow $			
8	Back-light	<ol> <li>The color of backlight should correspond its specification.</li> <li>Not allow flickering</li> </ol>			
9	Soldering	<ul> <li>(1) Not allow heavy dirty and solder ball on PCB.</li> <li>(The size of dirty refer to point and dust defect)</li> <li>(2) Over 50% of lead should be soldered on Land.</li> </ul>			
10	Wire	<ol> <li>(1) Copper wire should not be rusted</li> <li>(2) Not allow crack on copper wire connection.</li> <li>(3) Not allow reversing the position of the flat cable.</li> <li>(4) Not allow exposed copper wire inside the flat cable.</li> </ol>			
11*	РСВ	<ul><li>(1) Not allow screw rust or damage.</li><li>(2) Not allow missing or wrong putting of component.</li></ul>			

No	Item	Criterion
12	Protruded W: Terminal Width	$W_{\underline{N}}$ $W_{\underline{N}}$ $V_{\underline{Y}}$ $V_{\underline{Y}}$ $W_{\underline{N}}$ $V_{\underline{Y}$ $V_{\underline{Y}}$ $V_{$
13	ТАВ	1. Position H H H TAB ITO $W1 \le 1/3W$ H H H H H H H H H H H H H H H H H H H
		2 FPC bonding strength test F F FPC P (=F/FPC bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)
14	Total no. of acceptable Defect	<ul> <li>A. Zone</li> <li>Maximum 2 minor non-conformities per one unit.</li> <li>Defect distance: each point to be separated over 10mm</li> <li>B. Zone</li> <li>It is acceptable when it is no trouble for quality and assembly in customer's end product.</li> </ul>

## 9.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	60°C	48	
High temp. Operating	50°C	48	
Low temp. Storage	-10°C	48	No abnormalities
Low temp. Operating	0°C	48	in functions
Humidity	40°C/ 90%RH	48	and appearance
Temp. Cycle	$-10^{\circ}C \leftarrow 25^{\circ}C \rightarrow 60^{\circ}C$	10cycles	
	$(60 \min \leftarrow 5 \min \rightarrow 60 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature  $(20\pm8^{\circ}C)$ , normal humidity (below 65% RH), and in the area not exposed to direct sun light.

#### 9.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

#### **General Precautions:**

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting Orient Display.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or

twisting. Elastomer contacts are very delicate and missing pixels could result from slight

dislocation of any of the elements.

- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

#### **Static Electricity Precautions:**

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

#### **Soldering Precautions:**

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature:  $280^{\circ}C \pm 10^{\circ}C$
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

#### **Operation Precautions:**

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

#### **Limited Warranty**

Orient Display LCDs and modules are not consumer products, but may be incorporated by Orient Display customers into consumer products or components thereof, Orient Display does not warrant that its LCDs and components are fit for any such particular purpose.

- The liability of Orient Display is limited to repair or replacement on the terms set forth below. Orient Display will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between Orient Display and the customer, Orient Display will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with Orient Display general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.